
2SC5049

Silicon NPN Epitaxial

HITACHI

Application

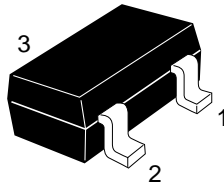
VHF / UHF wide band amplifier

Features

- High gain bandwidth product
 $f_T = 10 \text{ GHz Typ}$
- High gain, low noise figure
 $PG = 15.0 \text{ dB Typ}$, $NF = 1.2 \text{ dB Typ}$ at $f = 900 \text{ MHz}$

Outline

MPAK



1. Emitter
2. Base
3. Collector

Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	15	V
Collector to emitter voltage	V_{CEO}	8	V
Emitter to base voltage	V_{EBO}	1.5	V
Collector current	I_{C}	20	mA
Collector power dissipation	P_{C}	150	mW
Junction temperature	T_{j}	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

Electrical Characteristics ($T_a = 25^\circ\text{C}$)

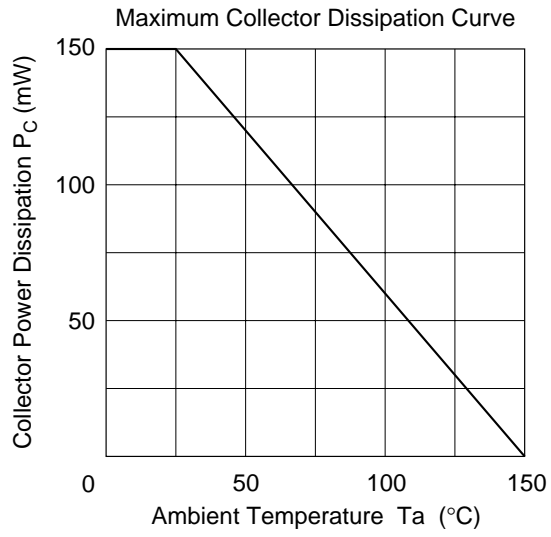
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Collector cutoff current	I_{CBO}	—	—	10	μA	$V_{\text{CB}} = 15 \text{ V}, I_{\text{E}} = 0$
	I_{CEO}	—	—	1	mA	$V_{\text{CE}} = 8 \text{ V}, R_{\text{BE}} = \infty$
Emitter cutoff current	I_{EBO}	—	—	10	μA	$V_{\text{EB}} = 1.5 \text{ V}, I_{\text{C}} = 0$
DC current transfer ratio	h_{FE}	50	120	250		$V_{\text{CE}} = 5 \text{ V}, I_{\text{C}} = 20 \text{ mA}$
Collector output capacitance	C_{ob}	—	0.45	0.8	pF	$V_{\text{CB}} = 5 \text{ V}, I_{\text{E}} = 0, f = 1 \text{ MHz}$
Gain bandwidth product	f_{T}	7.0	10.0	—	GHz	$V_{\text{CE}} = 5 \text{ V}, I_{\text{C}} = 10 \text{ mA}$
Power gain	PG	12.0	15.0	—	dB	$V_{\text{CE}} = 5 \text{ V}, I_{\text{C}} = 10 \text{ mA},$ $f = 900 \text{ MHz}$
Noise figure	NF	—	1.2	2.5	dB	$V_{\text{CE}} = 5 \text{ V}, I_{\text{C}} = 5 \text{ mA},$ $f = 900 \text{ MHz}$

Note: Marking is "YA-".

Attention: This device is very sensitive to electro static discharge.

It is recommended to adopt appropriate cautions when handling this transistor.

See characteristic curves of 2SC4784.





Hitachi Code	MPAK
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.011 g

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